

茂钿半導體股份有限公司 Mos-Tech Semiconductor Co.LTD.

MT2307

P-Channel Enhancement Mode Field Effect Transistor

FEATURES

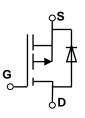
- Super high dense cell design for low RDS(ON)
- Rugged and reliable
- Simple drive requirement
- SOT-23 package

PRODUCT SUMMARY		
VDSS	V_{DSS} I_D $RDS(ON) (m \Omega) Typ$	
-20V	-4.6A	70@ VGS=-4.5V
		95@ VGS=-2.5V



NOTE: The MT2307 is available in a lead-free package





ABSOLUTE MAXIMUM RATINGS ($T_A=25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-20	V
Gate-Source Voltage	VGS	±12	V
Drain Current-Continuous ^a @Tj=125°C	ID	-4.6	А
- Pulse d^b	Ідм	-12	А
Drain-source Diode Forward Current ^a	Is	-1.25	А
Maximum Power Dissipation ^a	PD	1.25	W
Operating Junction and Storage Temperature Range	Тл,Тятб	-55 to 150	←

THERMAL CHARACTERISTICS

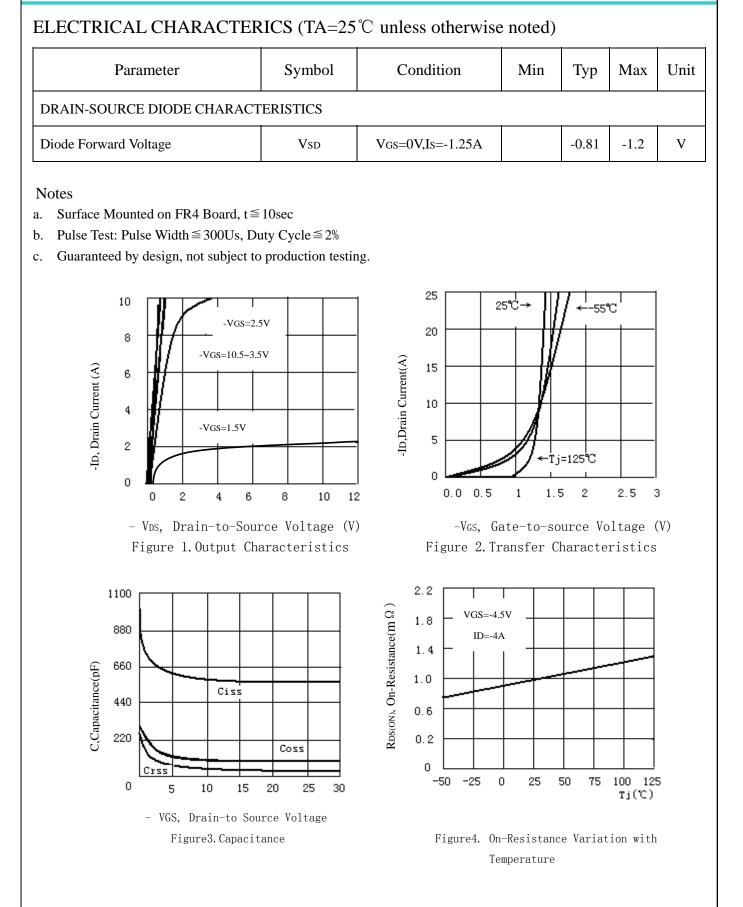
Thermal Resistance, Junction-to Ambient ^a	Rth JA	100	°C/W
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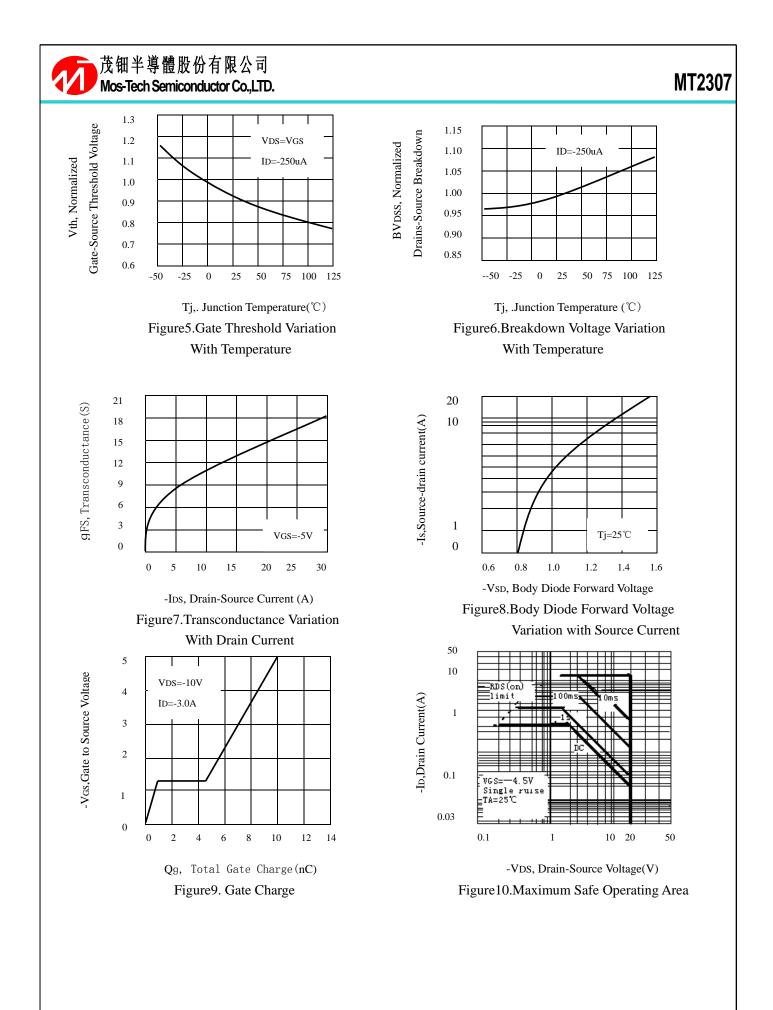
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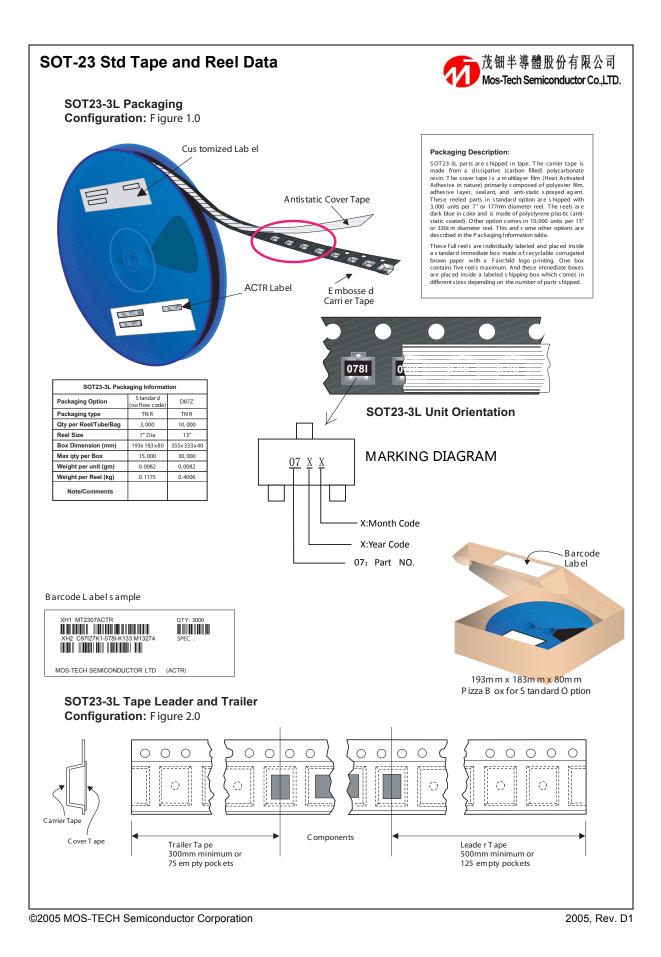
ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted) Symbol Condition Min Parameter Typ Max Unit OFF CHARACTERISTICS **BV**DSS Drain-Source Breakdown Voltage VGS=0V,ID=-250µA -20 V IDSS Zero Gate Voltage Drain Current VDS=-16V,VGS=0V 1 μA IGSS VGs=±10V,VDs=0V ± 100 Gate-Body Leakage nA ON CHARACTERITICS Gate Threshold Voltage VGs(th) VDS=VGS,ID=-250µA -0.5 -0.8 -1.5 V VGs=-4.5V,ID=-2.8A 70 90 Drain-Source On-State Resistance RDS(ON) $m\Omega$ VGs=-2.5V,ID=-2.0A 95 115 gfs Forward Transconductance VGS=-5V,ID=-5A 5 S DAYNAMIC CHARACTERISTICS CISS Input Capacitance 586 pF VDS=-10V,VGS=0V Coss **Output Capacitance** 101 pF f=1.0MHz Crss Reverse Transfer Capacitance 59 pF SWITCHING CHARACTERISISTICS td(ON) Turn-On Delay Time 6.5 ns VDD=-10VID=-2.8A, tr **Rise** Time 32.1 ns VGEN=-4.5V tD(OFF) Turn-Off Delay Time 58.4 ns RL=10ohm tf RGEN=60hm Fall Time 48 ns Qg **Total Gate Charge** 6 nC VDS=-10V,ID=-3A Qgs 1.35 Gate-Source Charge nC VGS = -4.5VQgd Gate-Drain Charge 1.5 nC

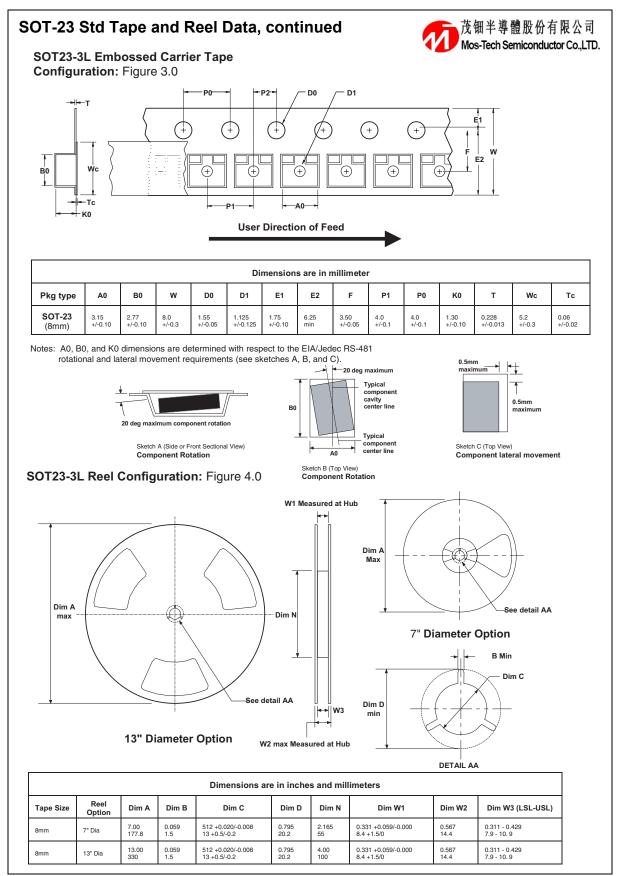


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MT2307







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